Product data sheet

#### **General description** 1.

The 74AUP1G11 provides a low-power, low-voltage single 3-input AND gate.

Schmitt trigger action at all inputs makes the circuit tolerant to slower input rise and fall times across the entire  $V_{CC}$  range from 0.8 V to 3.6 V.

This device ensures a very low static and dynamic power consumption across the entire V<sub>CC</sub> range from 0.8 V to 3.6 V.

This device is fully specified for partial power-down applications using I<sub>OFF</sub>. The I<sub>OFF</sub> circuitry disables the output, preventing the damaging backflow current through the device when it is powered down.

#### 2. **Features**

- Wide supply voltage range from 0.8 V to 3.6 V
  High noise immunity
  Complies with JEDEC standards:
  JESD8-12 (0.8 V to 1.3 V)
  JESD8-11 (0.9 V to 1.65 V)
- - JESD8-7 (1.2 V to 1.95 V)
  - ◆ JESD8-5 (1.8 V to 2.7 V)
  - ◆ JESD8-B (2.7 V to 3.6 V)
- ESD protection:
  - HBM JESD22-A114E Class 3A exceeds 5000 V
  - MM JESD22-A115-A exceeds 200 V
  - CDM JESD22-C101C exceeds 1000 V
- Low static power consumption;  $I_{CC} = 0.9 \mu A$  (maximum)
- Latch-up performance exceeds 100 mA per JESD 78 Class II
- Inputs accept voltages up to 3.6 V
- Low noise overshoot and undershoot < 10 % of V<sub>CC</sub>
- I<sub>OFF</sub> circuitry provides partial Power-down mode operation
- Multiple package options
- Specified from –40 °C to +85 °C and –40 °C to +125 °C



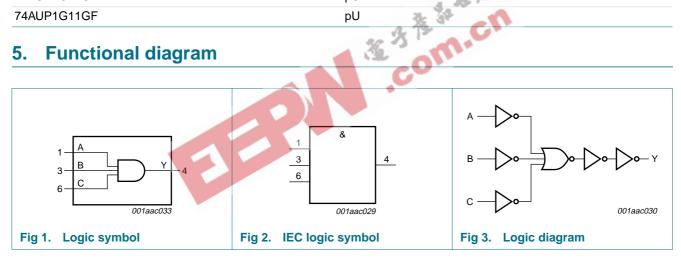
#### **Ordering information** 3.

Table 1. Ordering information											
Type number Package											
	Temperature range	Name	Description	Version							
74AUP1G11GW	–40 °C to +125 °C	SC-88	plastic surface-mounted package; 6 leads	SOT363							
74AUP1G11GM	–40 °C to +125 °C	XSON6	plastic extremely thin small outline package; no leads; 6 terminals; body 1 $\times$ 1.45 $\times$ 0.5 mm	SOT886							
74AUP1G11GF	–40 °C to +125 °C	XSON6	plastic extremely thin small outline package; no leads; 6 terminals; body 1 $\times$ 1 $\times$ 0.5 mm	SOT891							

#### Marking 4.

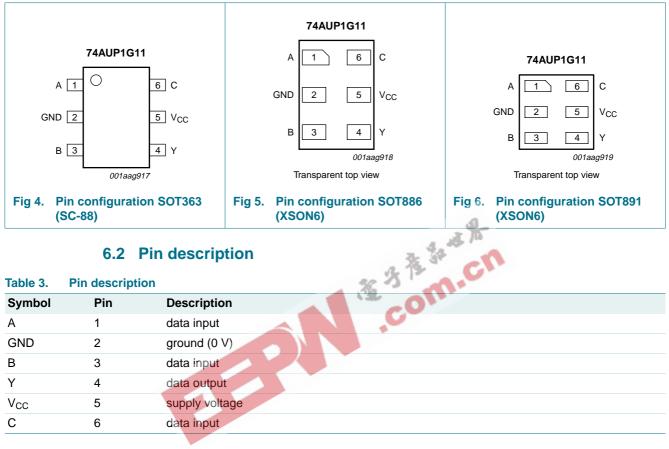
Table 2. Marking	
Type number	Marking code
74AUP1G11GW	pU
74AUP1G11GM	pU
74AUP1G11GF	pU 👷 😵 🧹

#### **Functional diagram** 5.



## 6. Pinning information

## 6.1 Pinning



## 7. Functional description

### Table 4. Function table<sup>[1]</sup>

Input	Output		
Α	В	C	Y
Н	Н	Н	Н
L	Х	Х	L
Х	L	Х	L
Х	Х	L	L

[1] H = HIGH voltage level;

L = LOW voltage level;

X = don't care.

#### **Limiting values** 8.

#### Table 5. **Limiting values**

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Max	Unit
V <sub>CC</sub>	supply voltage		-0.5	+4.6	V
I <sub>IK</sub>	input clamping current	V <sub>I</sub> < 0 V	-50	-	mA
VI	input voltage		<u>[1]</u> –0.5	+4.6	V
I <sub>OK</sub>	output clamping current	$V_{O} > V_{CC}$ or $V_{O} < 0 V$	-	±50	mA
Vo	output voltage	Active mode and Power-down mode	<u>[1]</u> –0.5	+4.6	V
lo	output current	$V_{O} = 0 V$ to $V_{CC}$	-	±20	mA
I <sub>CC</sub>	supply current		-	50	mA
I <sub>GND</sub>	ground current		-50	-	mA
T <sub>stg</sub>	storage temperature		-65	+150	°C
P <sub>tot</sub>	total power dissipation	$T_{amb} = -40 \ ^{\circ}C$ to +125 $^{\circ}C$	[2] _	250	mW

[1] The minimum input and output voltage ratings may be exceeded if the input and output current ratings are observed.

[2] For SC-88 packages: above 87.5 °C the value of  $P_{tot}$  derates linearly with 4.0 mW/K. com.cn For XSON6 packages: above 45 °C the value of  $\mathsf{P}_{tot}$  derates linearly with 2.4 mW/K. 

#### **Recommended operating conditions** 9.

Table 6.	Recommended operating	conditions			
Symbol	Parameter	Conditions	Min	Max	Unit
V <sub>CC</sub>	supply voltage		0.8	3.6	V
VI	input voltage		0	3.6	V
Vo	output voltage	Active mode	0	$V_{CC}$	V
		Power-down mode; $V_{CC} = 0 V$	0	3.6	V
T <sub>amb</sub>	ambient temperature		-40	+125	°C
$\Delta t / \Delta V$	input transition rise and f	all rate $V_{CC} = 0.8 \text{ V} \text{ to } 3.6 \text{ V}$	-	200	ns/V

## **10. Static characteristics**

### Table 7. Static characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
T <sub>amb</sub> = 2	:5 °C					
V <sub>IH</sub>	HIGH-level input voltage	$V_{CC} = 0.8 V$	$0.70 \times V_{CC}$	-	-	V
		$V_{CC} = 0.9 V$ to 1.95 V	$0.65 \times V_{CC}$	-	-	V
		$V_{CC}$ = 2.3 V to 2.7 V	1.6	-	-	V
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$	2.0	-	-	V
VIL	LOW-level input voltage	$V_{CC} = 0.8 V$	-	-	$0.30 \times V_{CC}$	V
		$V_{CC} = 0.9 V$ to 1.95 V	-	-	$0.35 \times V_{CC}$	V
		$V_{CC}$ = 2.3 V to 2.7 V	-	-	0.7	V
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$	-	-	0.9	V
V <sub>OH</sub>	HIGH-level output voltage	$V_{I} = V_{IH} \text{ or } V_{IL}$				
		$I_{O}$ = -20 $\mu$ A; $V_{CC}$ = 0.8 V to 3.6 V	V <sub>CC</sub> - 0.1	-	-	V
		$I_0 = -1.1 \text{ mA}; V_{CC} = 1.1 \text{ V}$	$0.75 \times V_{CC}$	-	-	V
		$I_{O} = -1.1 \text{ mA}; V_{CC} = 1.1 \text{ V}$ $I_{O} = -1.7 \text{ mA}; V_{CC} = 1.4 \text{ V}$ $I_{O} = -1.9 \text{ mA}; V_{CC} = 1.65 \text{ V}$	1.11	-	-	V
		$I_0 = -1.9 \text{ mA}; V_{CC} = 1.65 \text{ V}$	1.32	-	-	V
		$I_0 = -2.3 \text{ mA}; V_{CC} = 2.3 \text{ V}$	2.05	-	-	V
		$I_0 = -3.1 \text{ mA}; V_{CC} = 2.3 \text{ V}$	1.9	-	-	V
		$I_{O} = -2.7 \text{ mA}; V_{CC} = 3.0 \text{ V}$	2.72	-	-	V
		$I_0 = -4.0 \text{ mA}; V_{CC} = 3.0 \text{ V}$	2.6	-	-	V
V <sub>OL</sub>	LOW-level output voltage	$V_{I} = V_{IH} \text{ or } V_{IL}$				
		$I_0 = 20 \ \mu A; V_{CC} = 0.8 \ V \text{ to } 3.6 \ V$	-	-	0.1	V
		I <sub>O</sub> = 1.1 mA; V <sub>CC</sub> = 1.1 V	-	-	$0.3  imes V_{CC}$	V
		I <sub>O</sub> = 1.7 mA; V <sub>CC</sub> = 1.4 V	-	-	0.31	V
		I <sub>O</sub> = 1.9 mA; V <sub>CC</sub> = 1.65 V	-	-	0.31	V
		$I_0 = 2.3 \text{ mA}; V_{CC} = 2.3 \text{ V}$	-	-	0.31	V
		I <sub>O</sub> = 3.1 mA; V <sub>CC</sub> = 2.3 V	-	-	0.44	V
		$I_0 = 2.7 \text{ mA}; V_{CC} = 3.0 \text{ V}$	-	-	0.31	V
		$I_0 = 4.0 \text{ mA}; V_{CC} = 3.0 \text{ V}$	-	-	0.44	V
I <sub>I</sub>	input leakage current	$V_I = GND$ to 3.6 V; $V_{CC} = 0$ V to 3.6 V	-	-	±0.1	μA
I <sub>OFF</sub>	power-off leakage current	$V_1$ or $V_0 = 0$ V to 3.6 V; $V_{CC} = 0$ V	-	-	±0.2	μA
$\Delta I_{OFF}$	additional power-off leakage current	$V_1 \text{ or } V_0 = 0 \text{ V to } 3.6 \text{ V};$ $V_{CC} = 0 \text{ V to } 0.2 \text{ V}$	-	-	±0.2	μΑ
lcc	supply current	$V_{I} = \text{GND or } V_{\text{CC}}; I_{\text{O}} = 0 \text{ A};$ $V_{\text{CC}} = 0.8 \text{ V to } 3.6 \text{ V}$	-	-	0.5	μA
$\Delta I_{CC}$	additional supply current		[1] -	-	40	μΑ
CI	input capacitance	$V_{CC} = 0$ V to 3.6 V; $V_{I} = GND$ or $V_{CC}$	-	0.8	-	pF
C <sub>O</sub>	output capacitance	$V_{O} = GND; V_{CC} = 0 V$	-	1.7	-	pF

Low-power 3-input AND gate

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).								
Symbol	Parameter	Conditions	Min	Тур	Мах	Unit		
T <sub>amb</sub> = -4	40 °C to +85 °C							
V <sub>IH</sub>	HIGH-level input voltage	$V_{CC} = 0.8 V$	$0.70\times V_{CC}$	-	-	V		
		$V_{CC} = 0.9 V$ to 1.95 V	$0.65 \times V_{CC}$	-	-	V		
		$V_{CC}$ = 2.3 V to 2.7 V	1.6	-	-	V		
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$	2.0	-	-	V		
V <sub>IL</sub>	LOW-level input voltage	V <sub>CC</sub> = 0.8 V	-	-	$0.30 \times V_{CC}$	V		
		$V_{CC} = 0.9 V$ to 1.95 V	-	-	$0.35 \times V_{CC}$	V		
		$V_{CC} = 2.3 \text{ V} \text{ to } 2.7 \text{ V}$	-	-	0.7	V		
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$	-	-	0.9	V		
V <sub>OH</sub>	HIGH-level output voltage	$V_{I} = V_{IH} \text{ or } V_{IL}$						
		$I_O$ = –20 $\mu A;~V_{CC}$ = 0.8 V to 3.6 V	$V_{CC}-0.1$	-	-	V		
		$I_{O} = -1.1 \text{ mA}; V_{CC} = 1.1 \text{ V}$	$0.7\times V_{CC}$	-	-	V		
		$I_{O} = -1.7 \text{ mA}; V_{CC} = 1.4 \text{ V}$	1.03	-	-	V		
		$I_{O} = -1.9 \text{ mA}; V_{CC} = 1.65 \text{ V}$	1.30	-	-	V		
		$I_{O} = -1.9 \text{ mA}; V_{CC} = 1.65 \text{ V}$ $I_{O} = -2.3 \text{ mA}; V_{CC} = 2.3 \text{ V}$ $I_{O} = -3.1 \text{ mA}; V_{CC} = 2.3 \text{ V}$ $I_{O} = -2.7 \text{ mA}; V_{CC} = 3.0 \text{ V}$	1.97	-	-	V		
		$I_0 = -3.1 \text{ mA}; V_{CC} = 2.3 \text{ V}$	1.85	-	-	V		
		$I_0 = -2.7 \text{ mA}; V_{CC} = 3.0 \text{ V}$	2.67	-	-	V		
		$I_0 = -4.0 \text{ mA}; V_{CC} = 3.0 \text{ V}$	2.55	-	-	V		
V <sub>OL</sub>	LOW-level output voltage	$V_{I} = V_{IH} \text{ or } V_{IL}$						
		$I_0 = 20 \ \mu\text{A}; \ V_{CC} = 0.8 \ V \text{ to } 3.6 \ V$	-	-	0.1	V		
		$I_0 = 1.1 \text{ mA}; V_{CC} = 1.1 \text{ V}$	-	-	$0.3 \times V_{CC}$	V		
		$I_0 = 1.7 \text{ mA}; V_{CC} = 1.4 \text{ V}$	-	-	0.37	V		
		l <sub>O</sub> = 1.9 mA; V <sub>CC</sub> = 1.65 V	-	-	0.35	V		
		$I_{O}$ = 2.3 mA; $V_{CC}$ = 2.3 V	-	-	0.33	V		
		$I_0$ = 3.1 mA; $V_{CC}$ = 2.3 V	-	-	0.45	V		
		$I_{O}$ = 2.7 mA; $V_{CC}$ = 3.0 V	-	-	0.33	V		
		$I_{O}$ = 4.0 mA; $V_{CC}$ = 3.0 V	-	-	0.45	V		
l <sub>l</sub>	input leakage current	$V_{\rm I}$ = GND to 3.6 V; $V_{\rm CC}$ = 0 V to 3.6 V	-	-	±0.5	μΑ		
I <sub>OFF</sub>	power-off leakage current	$V_{I}$ or $V_{O}$ = 0 V to 3.6 V; $V_{CC}$ = 0 V	-	-	±0.5	μΑ		
$\Delta I_{OFF}$	additional power-off leakage current	$    V_{I} \text{ or } V_{O} = 0 \text{ V to } 3.6 \text{ V};                                   $	-	-	±0.6	μA		
I <sub>CC</sub>	supply current	$V_{I} = \text{GND or } V_{CC}; I_{O} = 0 \text{ A};$ $V_{CC} = 0.8 \text{ V to } 3.6 \text{ V}$	-	-	0.9	μA		
$\Delta I_{CC}$	additional supply current	$\label{eq:VI} \begin{array}{l} V_{I} = V_{CC} - 0.6 \; V; \; I_{O} = 0 \; A; \\ V_{CC} = 3.3 \; V \end{array}$	[1] -	-	50	μA		

#### Table 7. Static characteristics ... continued

Low-power 3-input AND gate

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).								
-	Parameter	Conditions	Min	Тур	Max	Unit		
T <sub>amb</sub> = -4	40 °C to +125 °C							
VIH	HIGH-level input voltage	$V_{CC} = 0.8 V$	$0.75 \times V_{CC}$	-	-	V		
		$V_{CC} = 0.9 V$ to 1.95 V	$0.70 \times V_{\text{CC}}$	-	-	V		
		$V_{CC} = 2.3 V \text{ to } 2.7 V$	1.6	-	-	V		
		$V_{CC} = 3.0 V \text{ to } 3.6 V$	2.0	-	-	V		
V <sub>IL</sub>	LOW-level input voltage	$V_{CC} = 0.8 V$	-	-	$0.25 \times V_{CC}$	V		
		$V_{CC} = 0.9 V$ to 1.95 V	-	-	$0.30 \times V_{CC}$	V		
		$V_{CC}$ = 2.3 V to 2.7 V	-	-	0.7	V		
		$V_{CC} = 3.0 V \text{ to } 3.6 V$	-	-	0.9	V		
V <sub>OH</sub>	HIGH-level output voltage	$V_{I} = V_{IH} \text{ or } V_{IL}$						
		$I_O$ = –20 $\mu\text{A};V_{CC}$ = 0.8 V to 3.6 V	$V_{CC} - 0.11$	-	-	V		
		$I_{O} = -1.1 \text{ mA}; V_{CC} = 1.1 \text{ V}$	$0.6 \times V_{CC}$	-	-	V		
		$I_{O} = -1.7 \text{ mA}; V_{CC} = 1.4 \text{ V}$	0.93	-	-	V		
		$I_{O} = -1.9 \text{ mA}; V_{CC} = 1.65 \text{ V}$	4,17	-	-	V		
		$I_{O} = -1.9 \text{ mA; } V_{CC} = 1.65 \text{ V}$ $I_{O} = -2.3 \text{ mA; } V_{CC} = 2.3 \text{ V}$ $I_{O} = -3.1 \text{ mA; } V_{CC} = 2.3 \text{ V}$ $I_{O} = -2.7 \text{ mA; } V_{CC} = 3.0 \text{ V}$	1.77	-	-	V		
		$I_0 = -3.1 \text{ mA}; V_{CC} = 2.3 \text{ V}$	1.67	-	-	V		
		$I_0 = -2.7 \text{ mA}; V_{CC} = 3.0 \text{ V}$	2.40	-	-	V		
		$I_0 = -4.0 \text{ mA}; V_{CC} = 3.0 \text{ V}$	2.30	-	-	V		
V <sub>OL</sub>	LOW-level output voltage	$V_{I} = V_{IH} \text{ or } V_{IL}$						
		$I_{O}$ = 20 $\mu$ A; $V_{CC}$ = 0.8 V to 3.6 V	-	-	0.11	V		
		I <sub>O</sub> = 1.1 mA; V <sub>CC</sub> = 1.1 V	-	-	$0.33 \times V_{CC}$	V		
		I <sub>O</sub> = 1.7 mA; V <sub>CC</sub> = 1.4 V	-	-	0.41	V		
		l <sub>O</sub> = 1.9 mA; V <sub>CC</sub> = 1.65 V	-	-	0.39	V		
		$I_{O}$ = 2.3 mA; $V_{CC}$ = 2.3 V	-	-	0.36	V		
		$I_{O}$ = 3.1 mA; $V_{CC}$ = 2.3 V	-	-	0.50	V		
		$I_{O}$ = 2.7 mA; $V_{CC}$ = 3.0 V	-	-	0.36	V		
		$I_{O}$ = 4.0 mA; $V_{CC}$ = 3.0 V	-	-	0.50	V		
l <sub>l</sub>	input leakage current	$V_{\rm I}$ = GND to 3.6 V; $V_{\rm CC}$ = 0 V to 3.6 V	-	-	±0.75	μΑ		
I <sub>OFF</sub>	power-off leakage current	$V_{I}$ or $V_{O}$ = 0 V to 3.6 V; $V_{CC}$ = 0 V	-	-	±0.75	μΑ		
$\Delta I_{OFF}$	additional power-off leakage current	$      V_{I} \text{ or } V_{O} = 0 \text{ V to } 3.6 \text{ V};                                   $	-	-	±0.75	μA		
I <sub>CC</sub>	supply current	$\label{eq:VI} \begin{array}{l} V_{I} = GND \text{ or } V_{CC}; \ I_{O} = 0 \ A; \\ V_{CC} = 0.8 \ V \ \text{to} \ 3.6 \ V \end{array}$	-	-	1.4	μA		
$\Delta I_{CC}$	additional supply current	$V_{I} = V_{CC} - 0.6 \text{ V}; I_{O} = 0 \text{ A};$ $V_{CC} = 3.3 \text{ V}$	<u>[1]</u> -	-	75	μΑ		

#### Static characteristics ... continued Table 7.

[1] One input at  $V_{CC}$  – 0.6 V, other input at  $V_{CC}$  or GND.

## **11. Dynamic characteristics**

### Table 8. Dynamic characteristics

Voltages are referenced to GND (ground = 0 V); for test circuit see Figure 8.

Symbol	Parameter	Conditions		25 °C		-4	0 °C to +1	125 °C	Unit
			Min	Typ <mark>[1]</mark>	Max	Min	Мах (85 °С)	Max (125 °C)	
C <sub>L</sub> = 5 pl	F								
t <sub>pd</sub>	propagation delay	A, B and C to Y; [2] see Figure 7							
		$V_{CC} = 0.8 V$	-	18.9	-	-	-	-	ns
		$V_{CC}$ = 1.1 V to 1.3 V	3.0	5.6	9.5	2.8	9.9	10.0	ns
		$V_{CC}$ = 1.4 V to 1.6 V	2.3	3.9	5.9	2.2	6.5	6.8	ns
		$V_{CC}$ = 1.65 V to 1.95 V	1.9	3.1	4.8	1.8	5.3	5.5	ns
		$V_{CC}$ = 2.3 V to 2.7 V	1.6	2.5	3.6	1.4	4.0	4.2	ns
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$	1.3	2.2	3.2	1.2	3.5	3.7	ns
C <sub>L</sub> = 10 p	pF				1				
t <sub>pd</sub>	propagation delay	A, B and C to Y; [2] see Figure 7		大教		2			
		V <sub>CC</sub> = 0.8 V		22.5	<u>n:</u>	-	-	-	ns
		V <sub>CC</sub> = 1.1 V to 1.3 V	3.5	6.5	11.1	3.3	11.6	11.8	ns
		V <sub>CC</sub> = 1.4 V to 1.6 V	2.8	4.5	6.8	2.6	7.5	7.8	ns
		V <sub>CC</sub> = 1.65 V to 1.95 V	2.4	3.7	5.6	2.1	6.2	6.4	ns
		$V_{CC}$ = 2.3 V to 2.7 V	1.9	3.0	4.4	1.7	4.8	5.1	ns
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$	1.7	2.8	4.0	1.5	4.3	4.5	ns
C <sub>L</sub> = 15 p	ρF								
<sup>t</sup> pd	propagation delay	A, B and C to Y; [2] see Figure 7							
		$V_{CC} = 0.8 V$	-	23.6	-	-	-	-	ns
		$V_{CC}$ = 1.1 V to 1.3 V	3.9	7.3	12.5	3.6	13.3	13.4	ns
		$V_{CC}$ = 1.4 V to 1.6 V	3.2	5.1	7.6	2.9	8.5	8.8	ns
		$V_{CC}$ = 1.65 V to 1.95 V	2.7	4.2	6.3	2.4	6.9	7.3	ns
		$V_{CC}$ = 2.3 V to 2.7 V	2.3	3.5	5.0	2.0	5.5	5.8	ns
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$	2.0	3.2	4.6	1.8	5.0	5.2	ns
C∟ = 30 p	pF								
t <sub>pd</sub>	propagation delay	A, B and C to Y; [2] see Figure 7							
		$V_{CC} = 0.8 V$	-	36.3	-	-	-	-	ns
		$V_{CC}$ = 1.1 V to 1.3 V	5.1	9.5	16.8	4.8	17.9	18.3	ns
		$V_{CC}$ = 1.4 V to 1.6 V	4.2	6.7	10.0	3.8	11.3	11.8	ns
		$V_{CC}$ = 1.65 V to 1.95 V	3.6	5.5	8.1	3.2	9.1	9.7	ns
		$V_{CC}$ = 2.3 V to 2.7 V	3.0	4.6	6.6	2.8	7.2	7.5	ns
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$	2.7	4.3	6.1	2.5	6.6	6.9	ns

Low-power 3-input AND gate

Table 8.	Dynamic	characteristics	continued
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Voltages are referenced to GND (around = 0 V): for test circuit see Figure 8.

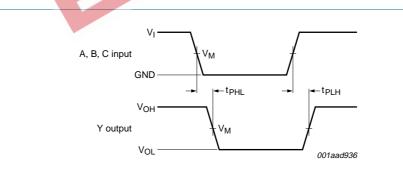
Symbol	Parameter	Conditions		25 °C			–40 °C to +125 °C			Unit
			Mi	in	Typ <mark>[1]</mark>	Мах	Min	Мах (85 °С)	Max (125 °C)	
C <sub>L</sub> = 5 pl	F, 10 pF, 15 pF and	30 pF								
C <sub>PD</sub> power dissipation capacitance		$f_i = 1 \text{ MHz};$ V <sub>I</sub> = GND to V <sub>CC</sub>	<u>[3]</u>							
		$V_{CC} = 0.8 V$	-	-	2.7	-	-	-	-	pF
		$V_{CC}$ = 1.1 V to 1.3 V	-	-	2.8	-	-	-	-	pF
		$V_{CC}$ = 1.4 V to 1.6 V	-	-	2.9	-	-	-	-	pF
		$V_{CC}$ = 1.65 V to 1.95 V	-	-	3.1	-	-	-	-	pF
		$V_{CC}$ = 2.3 V to 2.7 V	-	-	3.5	-	-	-	-	pF
		$V_{CC} = 3.0 \text{ V}$ to 3.6 V	-	-	4.1	-	-	-	-	pF

[1] All typical values are measured at nominal V<sub>CC</sub>.

- [2]  $t_{pd}$  is the same as  $t_{PLH}$  and  $t_{PHL}$ .
- ·Com.cn [3]  $C_{PD}$  is used to determine the dynamic power dissipation ( $P_D$  in  $\mu W$ ).
  - $P_{D} = C_{PD} \times V_{CC}^{2} \times f_{i} \times N + \Sigma (C_{L} \times V_{CC}^{2} \times f_{o}) \text{ where:}$  $f_i$  = input frequency in MHz;
    - $f_0$  = output frequency in MHz;
    - $C_{I} = load capacitance in pF;$
    - $V_{CC}$  = supply voltage in V;
    - N = number of inputs switching;

 $\Sigma(C_L \times V_{CC}^2 \times f_o)$  = sum of the outputs.

## 12. Waveforms



Measurement points are given in Table 9.

Logic levels:  $V_{\text{OL}}$  and  $V_{\text{OH}}$  are typical output voltage drop that occur with the output load.

#### Fig 7. Input A, B and C to output Y propagation delay times

#### Table 9. **Measurement points**

Supply voltage	Output	Input					
V <sub>CC</sub>	V <sub>M</sub>	V <sub>M</sub>	VI	$\mathbf{t}_{r} = \mathbf{t}_{f}$			
0.8 V to 3.6 V	$0.5 \times V_{CC}$	$0.5 \times V_{CC}$	V <sub>CC</sub>	≤ 3.0 ns			

### Low-power 3-input AND gate

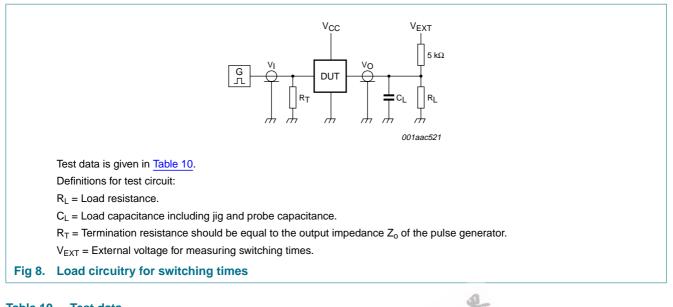


Table 10. Test data					
Supply voltage	Load		VEXT		
V <sub>CC</sub>	CL	R <sub>L</sub> [1]	t <sub>PLH</sub> , t <sub>PHL</sub>	t <sub>PZH</sub> , t <sub>PHZ</sub>	t <sub>PZL</sub> , t <sub>PLZ</sub>
0.8 V to 3.6 V	5 pF, 10 pF, 15 pF and 30 pF	5 kΩ or 1 MΩ	open	GND	$2 \times V_{CC}$

[1] For measuring enable and disable times  $R_L = 5 \text{ k}\Omega$ , for measuring propagation delays, setup and hold times and pulse width  $R_L = 1 \text{ M}\Omega$ .

Low-power 3-input AND gate

## 13. Package outline

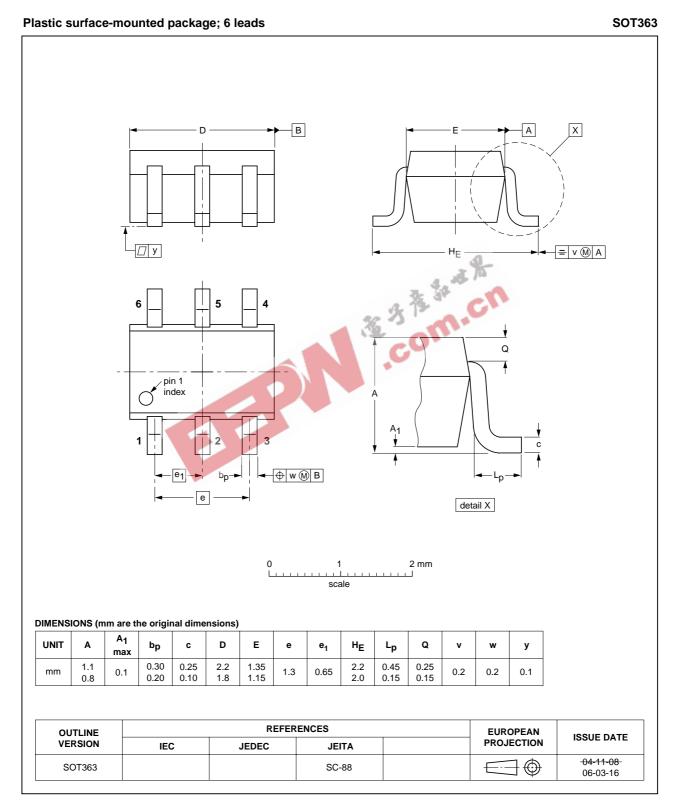
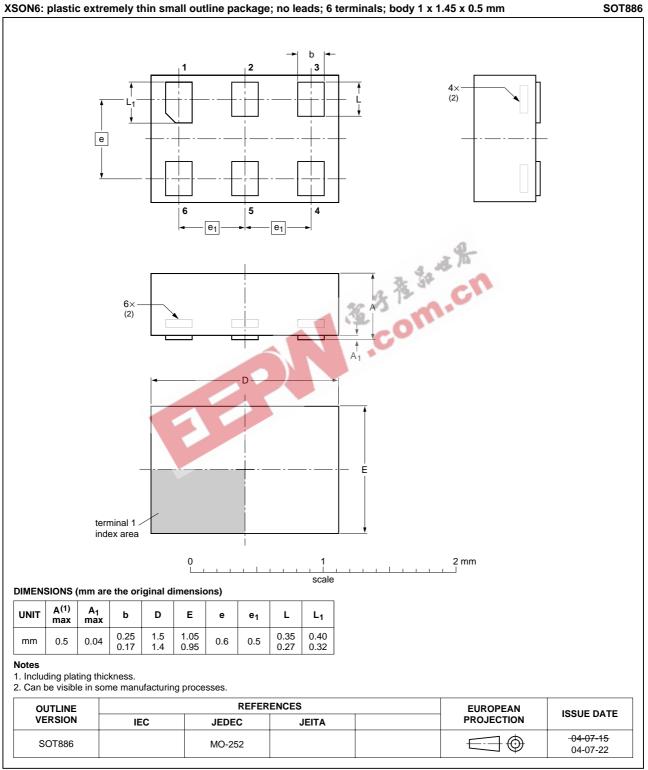


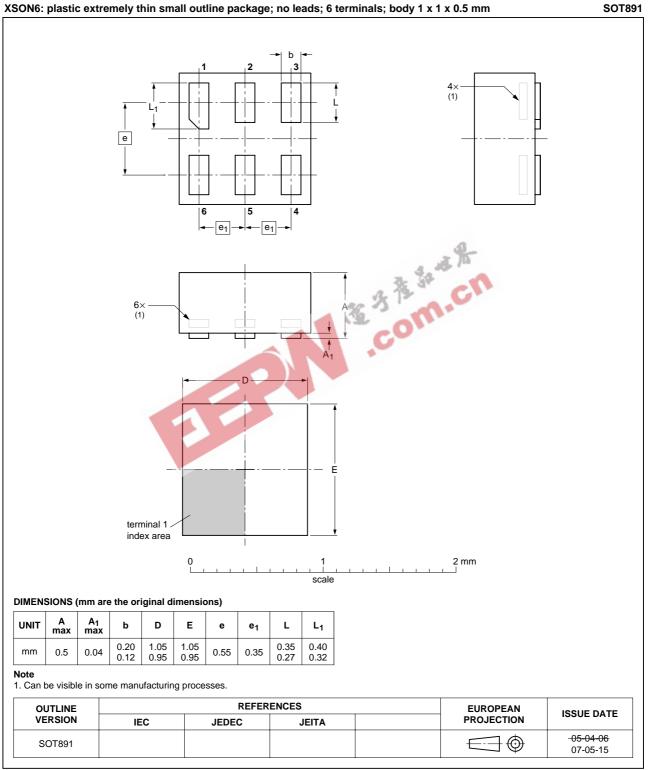
Fig 9. Package outline SOT363 (SC-88)



XSON6: plastic extremely thin small outline package; no leads; 6 terminals; body 1 x 1.45 x 0.5 mm

### Fig 10. Package outline SOT886 (XSON6)

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XSON6: plastic extremely thin small outline package; no leads; 6 terminals; body 1 x 1 x 0.5 mm

### Fig 11. Package outline SOT891 (XSON6)



## 14. Abbreviations

Description Charged Device Model
Charged Device Model
Complementary Metal Oxide Semiconductor
Device Under Test
ElectroStatic Discharge
Human Body Model
Machine Model

## 15. Revision history

Table 12. Revision his	story			
Document ID	Release date	Data sheet status	Change notice	Supersedes
74AUP1G11_1	20070904	Product data sheet		-
			Com.cn	

## **16. Legal information**

### 16.1 Data sheet status

Document status[1][2]	Product status <sup>[3]</sup>	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

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# 74AUP1G11

Low-power 3-input AND gate

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